Dual 4-Stage Binary Counter

The SN74LS393 contains a pair of high-speed 4-stage ripple counters.

Each half of the LS393 operates as a Modulo-16 binary divider, with the last three stages triggered in a ripple fashion. In the LS393, the flip-flops are triggered by a HIGH-to-LOW transition of their CP inputs. Each half of each circuit type has a Master Reset input which responds to a HIGH signal by forcing all four outputs to the LOW state.

- Dual Versions
- Individual Asynchronous Clear for Each Counter
- Typical Max Count Frequency of 50 MHz
- Input Clamp Diodes Minimize High Speed Termination Effects

GUARANTEED OPERATING RANGES

Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current - High			-0.4	mA
I _{OL}	Output Current - Low			8.0	mA



ON Semiconductor™

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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 646



SOIC D SUFFIX CASE 751A



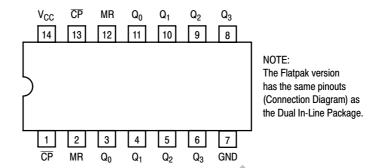
SOEIAJ M SUFFIX CASE 965

ORDERING INFORMATION

Device	Package	Shipping
SN74LS393N	14 Pin DIP	2000 Units/Box
SN74LS393D	SOIC-14	55 Units/Rail
SN74LS393DR2	SOIC-14	2500/Tape & Reel
SN74LS393M	SOEIAJ-14	See Note 1
SN74LS393MEL	SOEIAJ-14	See Note 1

 For ordering information on the EIAJ version of the SOIC package, please contact your local ON Semiconductor representative.

CONNECTION DIAGRAM DIP (TOP VIEW)



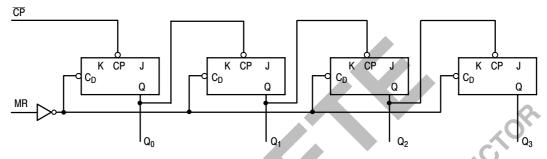
		LOADING	(Note a)
PIN NAM	IES	HIGH	LOW
CP	Clock (Active LOW Going Edge)		
CP ₀	Input to +16 (LS393) Clock (Active LOW Going Edge)	0.5 U.L.	1.0 U.L.
	Input to ÷2 (LS390)	0.5 U.L.	1.0 U.L.
CP ₁	Input to ÷ 5 (LS390)	0.5 U.L.	1.5 U.L.
MR Oo = Oo	Clock (Active LOW Going Edge) Input to ÷ 5 (LS390) Master Reset (Active HIGH) Input Flip-Flop Outputs Unit Load (U.L.) = 40 µA HIGH/1.6 mA LOW	0.5 U.L.	0.25 U.L.
03			C 1
NOTES: a) 1 TTI	Unit Load (U.L.) = 40 uA HIGH/1 6 mA LOW	50.0	
		B CV	Oly.
		0, 14	
	CV X	y 08.	
		, ^C O.	
	G C		
	الم م الد		
	4,71,71,		
	-01-61		
	,0,0,0		
	COV ARIV		
7.0			
	Q.V		
8,			

FUNCTIONAL DESCRIPTION

Each half of the SN74LS393 operates in the Modulo 16 binary sequence, as indicated in the ±16 Truth Table. The first flip-flop is triggered by HIGH-to-LOW transitions of the CP input signal. Each of the other flip-flops is triggered by a HIGH-to-LOW transition of the Q output of the preceding flip-flop. Thus state changes of the Q outputs do

not occur simultaneously. This means that logic signals derived from combinations of these outputs will be subject to decoding spikes and, therefore, should not be used as clocks for other counters, registers or flip-flops. A HIGH signal on MR forces all outputs to the LOW state and prevents counting.

SN74LS393 LOGIC DIAGRAM (one half shown)



TRUTH TABLE

	COUNT	ĺ	OUTPUTS						
1	COUNT	ď	Q_2	Q ₁	Q ₀	C			
	0 1 2 3			TILL	TLIT	3			
	4 5 6 7		1111	TIE	711	0,70			
	8 9 10 11	TETT	ددد	LLHH	LHLH				
	12 13 14 15	+++=		LLEE	- I I - I				

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits					
Symbol	Parameter		Min	Тур	Max	Unit	Tes	t Conditions
V _{IH}	Input HIGH Voltage		2.0			V	Guaranteed Inpu All Inputs	t HIGH Voltage for
V _{IL}	Input LOW Voltage				0.8	V	Guaranteed Inpu All Inputs	t LOW Voltage for
V _{IK}	Input Clamp Diode Volt	age		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	–18 mA
V _{OH}	Output HIGH Voltage		2.7	3.5		V	V _{CC} = MIN, I _{OH} = or V _{IL} per Truth T	
.,	0 1 110040771			0.25	0.4	V	I _{OL} = 4.0 mA	V _{CC} = V _{CC} MIN,
V _{OL}	Output LOW Voltage			0.35	0.5	V	I _{OL} = 8.0 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
	langet LIICH Commont				20	μΑ	$V_{CC} = MAX, V_{IN}$	= 2.7 V
l I _{IH}	Input HIGH Current				0.1	mA	$V_{CC} = MAX, V_{IN}$	= 7.0 V
		MR			-0.4	mA		
I _{IL}	Input LOW Current	CP, CP ₀			-1.6	mA	$V_{CC} = MAX, V_{IN}$	= 0.4 V
		CP₁			-2.4	mA		10
I _{OS}	Short Circuit Current (N	lote 2)	-20		-100	mA	V _{CC} = MAX	
I _{CC}	Power Supply Current				26	mA	V _{CC} = MAX	70.

^{2.} Not more than one output should be shorted at a time, nor for more than 1 second.

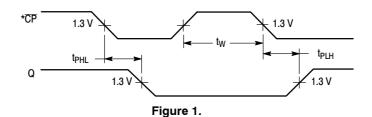
AC CHARACTERISTICS ($T_A = 25^{\circ}C$, $V_{CC} = 5.0 \text{ V}$)

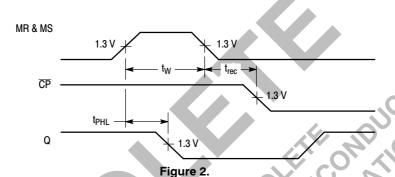
			Limits	0	9	, O,
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
f _{MAX}	Maximum Clock Frequency \overline{CP}_0 to Q_0	25	35		MHz	
f _{MAX}	Maximum Clock Frequency CP ₁ to Q ₁	20	7		MHz	
t _{PLH} t _{PHL}	Propagation Delay, CP to Q ₀		12 13	20 20	ns	C _L = 15 pF
t _{PLH} t _{PHL}	CP to Q ₃		40 40	60 60	ns	
t _{PHL}	MR to Any Output		24	39	ns	

AC SETUP REQUIREMENTS ($T_A = 25$ °C, $V_{CC} = 5.0 \text{ V}$)

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _W	Clock Pulse Width	20			ns	
t _W	MR Pulse Width	20			ns	V _{CC} = 5.0 V
t _{rec}	Recovery Time	25			ns	

AC WAVEFORMS



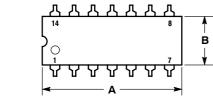


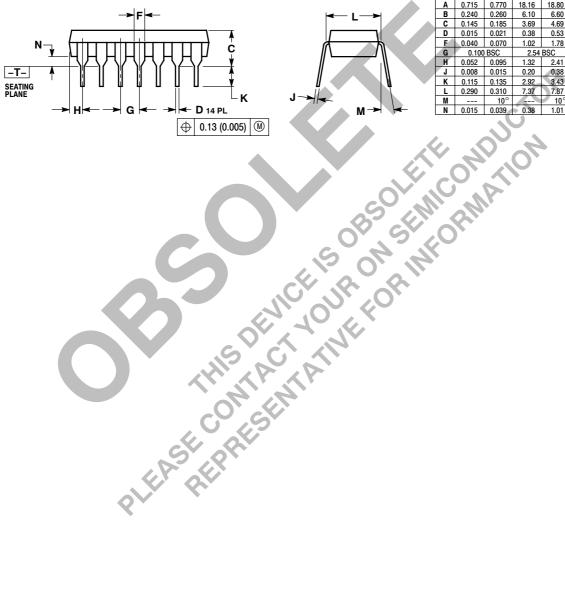
*The number of Clock Pulses required between t_{PHL} and t_{PLH} measurements can be determined from the appropriate Truth Table

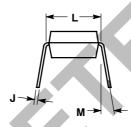
PACKAGE DIMENSIONS

N SUFFIX

PLASTIC PACKAGE CASE 646-06 **ISSUE M**







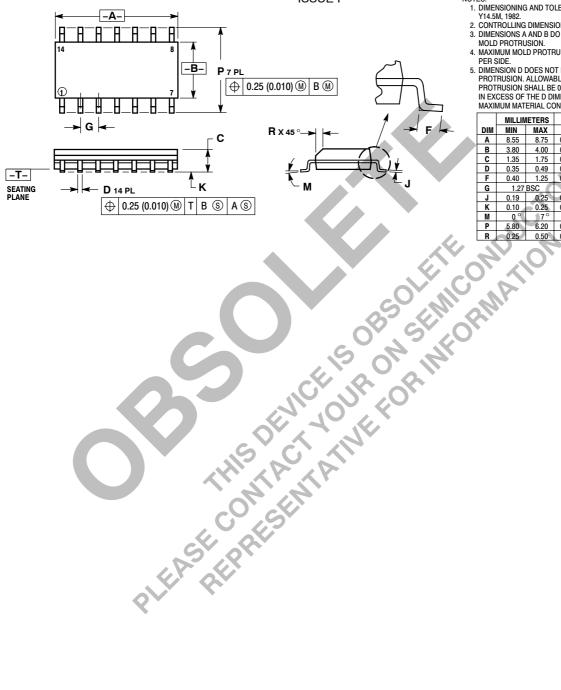
- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI
- . DIMENSIONING AND TOLERANGING FER ANY 14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
 5. ROUNDED CORNERS OPTIONAL.

		INC	HES	MILLIN	IETERS
	DIM	MIN	MAX	MIN	MAX
	Α	0.715	0.770	18.16	18.80
	В	0.240	0.260	6.10	6.60
J	С	0.145	0.185	3.69	4.69
1	D	0.015	0.021	0.38	0.53
	F	0.040	0.070	1.02	1.78
	G	0.100	BSC	2.54	BSC
	Н	0.052	0.095	1.32	2.41
ı	7	0.008	0.015	0.20	0.38
	K	0.115	0.135	2.92	3.43
	L	0.290	0.310	7.37	7.87
	M		10°	4	10°
	N	0.015	0.039	0.38	1.01

PACKAGE DIMENSIONS

D SUFFIX

PLASTIC SOIC PACKAGE CASE 751A-03 **ISSUE F**



NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: MILLIMETER.
 3. DIMENSIONS A AND B DO NOT INCLUDE
- MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- PER SIDE.

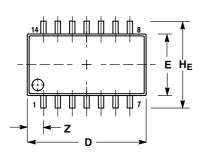
 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

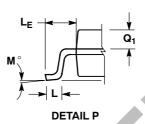
	MILLIN	IETERS	INCHES		
DIM	MIN	MAX	MIN	MAX	
Α	8.55	8.75	0.337	0.344	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.054	0.068	
D	0.35	0.49	0.014	0.019	
F	0.40	1.25	0.016	0.049	
G	1.27	BSC	0.050 BSC		
J	0.19	0.25	0.008	0.009	
K	0.10	0.25	0.004	0.009	
M	0°	17°	0 °	7°	
Р	5.80	6.20	0.228	0.244	
R	0.25	0.50	0.010	0.019	
			3		

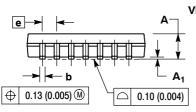
PACKAGE DIMENSIONS

M SUFFIX

SOEIAJ PACKAGE CASE 965-01 **ISSUE O**









NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETER.
- DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE
- TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
- THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

	MILLIMETERS		INC	HES	
DIM	MIN	MAX	MIN	MAX	
Α		2.05		0.081	
A ₁	0.05	0.20	0.002	0.008	
b	0.35	0.50	0.014	0.020	
C	0.18	0.27	0.007	0.011	
D	9.90	10.50	0.390	0.413	
E	5.10	5.45	0.201	0.215	
е	1.27	BSC	0.050 BSC		
HE	7.40	8.20	0.291	0.323	
0.50	0.50	0.85	0.020	0.033	
L.	1.10	1.50	0.043	0.059	
M	0 °	10 °	0 °	10°	
Q_1	0.70	0.90	0.028	0.035	
Ž		1.42		0.056	

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